### 54LVXC4245

54LVXC4245 8-Bit Dual Supply Configurable Voltage Interface Transceiver with TRI-STATE® Outputs



Literature Number: SNOS451A



### 54LVXC4245

# 8-Bit Dual Supply Configurable Voltage Interface Transceiver with TRI-STATE® Outputs

### **General Description**

The LVXC4245 is a 24-pin dual-supply, 8-bit configurable voltage interface transceiver suited for real time configurable I/O applications. The  $V_{\rm CCA}$  pin accepts a 5V supply level. The "A" port is a dedicated 5V port. The  $V_{\rm CCB}$  pin accepts a 3V-to-5V supply level. The "B" port is configured to track the  $V_{\rm CCB}$  supply level respectively. A 5V level on the  $V_{\rm CC}$  pin will configure the I/O pins at a 5V level and a 3V  $V_{\rm CC}$  will configure the I/O pins at a 3V level. This device will allow the  $V_{\rm CCB}$  voltage source pin and I/O pins on the "B" port to float when  $\overline{\rm OE}$  is HIGH. This feature is necessary to buffer data to and from a socket that permits live insertion and removal during normal operation.

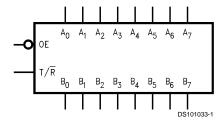
### **Features**

- Bidirectional interface between 5V and 3V-to-5V buses
- Control inputs compatible with TTL level
- Outputs source/sink up to 24 mA
- Available in Cerpack and CDIP packages
- Implements patented EMI reduction circuitry
- Flexible V<sub>CCB</sub> operating range
- Allows B port and V<sub>CCB</sub> to float simultaneously when OE is HIGH
- Functionally compatible with the 54 series 245
- Standard Microcircuit Drawing (SMD) 5962-9862001

### **Ordering Code**

Order Number	Package Number	Package Description
54LVXC4245W-QML	W24C	24-Lead Ceramic Flatpack
54LVXC4245J-QML	J24F	24-Lead Ceramic Dual-in-line

### **Logic Symbol**

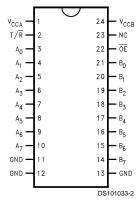


### **Pin Descriptions**

Pin Names	Description
ŌĒ	Output Enable Input
T/R	Transmit/Receive Input
A <sub>0</sub> -A <sub>7</sub>	Side A Inputs or TRI-STATE Outputs
B <sub>0</sub> -B <sub>7</sub>	Side B Inputs or TRI-STATE Outputs

### **Connection Diagram**

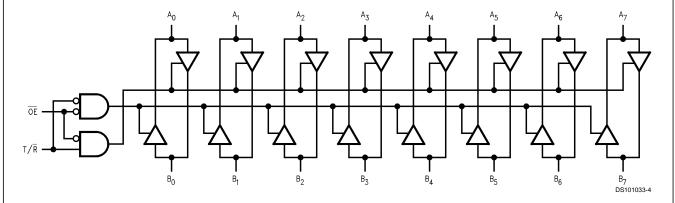
### Pin Assignment for Cerpack and CDIP



Inputs		Outputs
ŌĒ	T/R	
L	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	X	HIGH-Z State

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## Logic Diagram



### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V <sub>CCA</sub> ,V <sub>CCB</sub> )	-0.5V to +7.0V
DC Input Voltage (V <sub>I</sub> ) @ OE, T/R	–0.5V to $V_{\rm CCA}$ +0.5V
DC Input/Output Voltage (V <sub>I/O</sub> )	
@ A <sub>n</sub>	–0.5V to $V_{\rm CCA}$ +0.5V
@ B <sub>n</sub>	–0.5V to $V_{\rm CCB}$ +0.5V
DC Input Diode Current (I <sub>IK</sub> ) @ OE, T/R	±20 mA
DC Output Diode Current (I <sub>OK</sub> )	±50 mA
DC Output Source or Sink Current (I <sub>O</sub> )	±50 mA
DC V <sub>CC</sub> or Ground Current	
Per Output Pin (I <sub>CC</sub> or I <sub>GND</sub> )	±50 mA
and Max Current	±200 mA
Storage Temperature Range	

## Recommended Operating Conditions (Note 2)

 $V_{CC}$  @ 3V, 4.5V, 5.5V

Supply Voltage V <sub>CCA</sub>	4.5V to 5.5V 2.7V to 5.5V
V <sub>CCB</sub>	2.7 \ 10 5.5 \
Input Voltage (V <sub>I</sub> ) @ $\overline{\sf OE}$ , T/ $\overline{\sf R}$	$0V$ to $V_{CCA}$
Input/Output Voltage (V <sub>I/O</sub> )	
@A <sub>n</sub>	0V to $V_{CCA}$
@B <sub>n</sub>	0V to $V_{CCB}$
Free Air Operating Temperature (T <sub>A</sub> )	-55°C to +125°C
Minimum Input Edge Rate (ΔV/Δt)	8 ns/V
$V_{\text{IN}}$ from 30% to 70% of $V_{\text{CC}}$	

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The A port unused pins (inputs and I/O's) must be held HIGH or LOW. They may not float.

### **DC Electrical Characteristics**

 $(T_{STG})$ 

Symbol	Parameter		V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	$T_A = -55^{\circ}C$ to +125°C	Units	Conditions
					Guaranteed Limits		
$V_{IHA}$	Minimum High Level	A <sub>n</sub>	4.5	2.7	2.0	V	V <sub>OUT</sub> ≤ 0.1V
	Input Voltage	ŌĒ	4.5	3.6	2.0		or
		T/R	5.5	5.5	2.0		≥ V <sub>CC</sub> - 0.1V
V <sub>IHB</sub>		B <sub>n</sub>	4.5	2.7	2.0	7	
			4.5	3.6	2.0		
			4.5	5.5	3.85		
V <sub>ILA</sub>	Maximum Low Level	A <sub>n</sub>	4.5	2.7	0.8	V	V <sub>OUT</sub> ≤ 0.1V
	Input Voltage	ŌĒ	4.5	3.6	0.8		or
		T/R	5.5	5.5	0.8		≥ V <sub>CC</sub> - 0.1V
V <sub>ILB</sub>		B <sub>n</sub>	4.5	2.7	0.8	7	
			4.5	3.6	0.8		
			4.5	5.5	1.65		
V <sub>OHA</sub>	Minimum High Level	•	4.5	2.7	4.4	V	I <sub>OH</sub> = -100 μA
	Output Voltage		5.5	5.5	5.4		I <sub>OH</sub> = -100 μA
			4.5	3.0	3.7		$I_{OH} = -24 \text{ mA}$
			4.5	4.5	3.7		$I_{OH} = -24 \text{ mA}$
V <sub>OHB</sub>			4.5	2.7	2.6	V	I <sub>OH</sub> = -100 μA
			5.5	5.5	5.4		I <sub>OH</sub> = -100 μA
			4.5	2.7	2.2		$I_{OH} = -12 \text{ mA}$
			4.5	3.0	2.4		$I_{OH} = -12 \text{ mA}$
			4.5	3.0	2.2		$I_{OH} = -24 \text{ mA}$
			4.5	4.5	3.7		$I_{OH} = -24 \text{ mA}$

-65°C to +150°C

### DC Electrical Characteristics (Continued)

Symbol	ol Parameter		V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	T <sub>A</sub> = -55°C to +125°C	Units	Conditions
					Guaranteed Limits		
V <sub>OLA</sub>	Maximum Low Level		4.5	2.7	0.1	V	I <sub>OL</sub> = 100 μA
	Output Voltage		5.5	5.5	0.1		I <sub>OL</sub> = 100 μA
			4.5	3.0	0.4		I <sub>OL</sub> = 24 mA
			4.5	4.5	0.4		I <sub>OL</sub> = 24 mA
V <sub>OLB</sub>			4.5	2.7	0.1	V	I <sub>OL</sub> = 100 μA
			5.5	5.5	0.1		I <sub>OL</sub> = 100 μA
			4.5	2.7	0.3		I <sub>OL</sub> = 12 mA
			4.5	3.0	0.3		I <sub>OL</sub> = 12 mA
			4.5	3.0	0.4		I <sub>OL</sub> = 24 mA
			4.5	4.5	0.4		I <sub>OL</sub> = 24 mA
I <sub>IN</sub>	Maximum Input Leakage		5.5	3.6	±1.0	μA	$V_I = V_{CCA}$ , GND
	Current @ OE, T/R		5.5	5.5	±1.0		
I <sub>OZA</sub>	Maximum TRI-STATE		5.5	3.6	±5.0	μA	$V_{I} = V_{IL}, V_{IH}$
	Output Leakage @ A <sub>n</sub>		5.5	5.5	±5.0		$\overline{OE} = V_{CCA}$
							$V_O = V_{CCA}$ , GND
$I_{OZB}$	Maximum TRI-STATE		5.5	3.6	±5.0	μA	$V_{I} = V_{IL}, V_{IH},$
	Output Leakage @ B <sub>n</sub>		5.5	5.5	±5.0		$\overline{OE} = V_{CCA}$
							$V_O = V_{CCB}$ , GND
$\Delta I_{CC}$	Maximum	All Inputs	5.5	5.5	1.5	mA	$V_{I} = V_{CC} - 2.1V$
	I <sub>CC</sub> /Input	B <sub>n</sub>	5.5	3.6	0.5	mA	$V_I = V_{CCB} - 0.6V$
I <sub>CCA1</sub>	Quiescent V <sub>CCA</sub>						$A_n = V_{CCA}$ or GND
	Supply Current as B Por	t Floats	5.5	Open	40	μΑ	$B_n = Open, \overline{OE} = V_{CCA}$ $T/\overline{R} = V_{CCA}, V_{CCB} = Open$
$I_{CCA2}$	Quiescent V <sub>CCA</sub>						$A_n = V_{CCA}$ or GND
	Supply Current		5.5	3.6	40	μA	$B_n = V_{CCB}$ or GND
			5.5	5.5	40		$\overline{OE}$ = GND, T/ $\overline{R}$ = GND
I <sub>CCB</sub>	Quiescent V <sub>CCB</sub>						$A_n = V_{CCA}$ or GND
	Supply Current		5.5	3.6	10	μA	$B_n = V_{CCB}$ or GND
			5.5	5.5	40		$\overline{OE} = GND, T/\overline{R} =$
V <sub>OLPA</sub>	Quiet Output Maximum		5.0	3.3	1.5	V	V <sub>CCA</sub> (Note 3)
* OLPA	Dynamic V <sub>OL</sub>		5.0	5.0	1.5	, v	(. 1010 0)
V <sub>OLPB</sub>	J Jilaililo VOL		5.0	3.3	0.8	V	(Note 3)
* OLPB			5.0	5.0	1.5	, v	(. 1010 0)
V <sub>OLVA</sub>	Quiet Output Minimum		5.0	3.3	-1.1	V	(Note 3)
OLVA	Dynamic V <sub>OL</sub>		5.0	5.0	-1.2	ľ	(.1010 0)
V <sub>OLVB</sub>			5.0	3.3	-0.7	V	(Note 3)
* OLVB			5.0	5.0	-0. <i>1</i> -1.1	, v	(14010-0)
	lay number of outputs defined as (r		1	1			

 $\textbf{Note 3:} \ \ \text{Max number of outputs defined as (n). Data inputs are driven 0V to V_{CC} level; one output at GND.}$ 

### **AC Electrical Characteristics**

Symbol Parameter		_	50 pF	C <sub>L</sub> =	Units		
			.5V to 5.5V	V <sub>CCA</sub> = 4			
			.5V to 5.5V	V <sub>CCB</sub> = 2			
		$T_A = -55^{\circ}$	$T_A = -55^{\circ}C \text{ to } +125^{\circ}C$		$T_A = -55^{\circ}C \text{ to } +125^{\circ}C$		
		Min	Max	Min	Max		
$t_PHL$	Propagation	1.0	8.0	1.0	9.5	ns	
t <sub>PLH</sub>	Delay A to B	1.0	8.0	1.0	9.5		
t <sub>PHL</sub>	Propagation	1.0	8.0	1.0	9.5	ns	
$t_{PLH}$	Delay B to A	1.0	8.0	1.0	9.5		
t <sub>PZL</sub>	Output Enable	1.0	9.5	1.0	12.0	ns	
$t_{PZH}$	Time OE to B	1.0	9.5	1.0	12.0		
t <sub>PZL</sub>	Output Enable	1.0	11.5	1.0	13.0	ns	
$t_{PZH}$	Time OE to A	1.0	11.5	1.0	13.0		
t <sub>PHZ</sub>	Output Disable	1.0	7.0	1.0	7.5	ns	
$t_{PLZ}$	Time OE to B	1.0	7.0	1.0	7.5		
t <sub>PHZ</sub>	Output Disable	0.5	7.0	0.5	7.0	ns	
$t_{PLZ}$	Time OE to A	0.5	7.0	0.5	7.0		
t <sub>OSHL</sub>	Output to Output						
toslh	Skew (Note 4)		1.5		1.5	ns	
	Data to Output						

Note 4: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH to LOW ( $t_{OSHL}$ ) or LOW to HIGH ( $t_{OSLH}$ ). Parameter guaranteed by design.

### Capacitance

Symbol	Parameter	Max	Units	Conditions	
C <sub>IN</sub>	Input Capacitance	10	pF	V <sub>CC</sub> = Open	
C <sub>I/O</sub>	Input/Output Capacitance	12	pF	$V_{CCA} = 5V, V_{CCB} = 3.3V$	
C <sub>PD</sub>	Power Dissipation Capacitance	A→B	50	pF	V <sub>CCA</sub> = 5V
		B→A	50	pF	V <sub>CCB</sub> = 3.3V

Note 5: C<sub>PD</sub> is measured at 10 MHz.

### Configurable I/O Application for mixed or unknown Voltages

LVXC4245 is designed to solve 3V/5V interfacing issues when CMOS devices cannot tolerate I/O levels above their applied  $\rm V_{CC}.$  If an I/O pin of 3V ICs is driven by 5V ICs, the P-Channel transistor in 3V ICs will conduct causing current flow from I/O bus to the 3V power supply. The resulting high current flow can cause destruction of 3V ICs through latchup effects. To prevent this problem, a current limiting resistor is used typically under direct connection of 3V ICs and 5V ICs, but it causes speed degradation.

In a better solution, the LVXC4245 configures two different output levels to handle the dual supply interface issues. The

"A" port is a dedicated 5V port to interface 5V ICs. The "B" port is configurable and accepts a 3V-to-5V supply level. This configurable "B" port provides maximum flexibility for interfacing to unknown supply voltages, for interfacing to supply voltages which may change in the future, or for providing flexibility when supplying systems to multiple customers with varying power supply requirements. *Figure 1* shows how the LVXC4245 fits into a system with a 3V subsystem and a 5V subsystem.

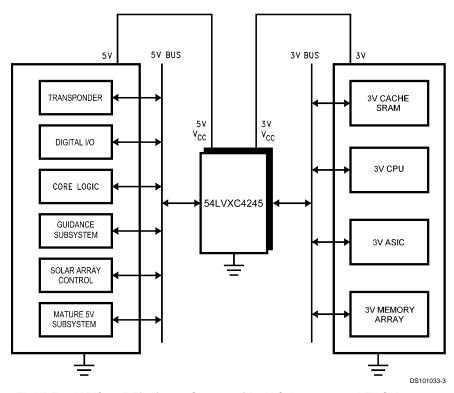


FIGURE 1. LVXC4245 Fits into a System with 3V Subsystem and 5V Subsystem

## Configurable I/O Application for mixed or unknown Voltages

(Continued)

Additionally, the LVXC4245 solves two other unique problems: when interfacing to non-TTL compatible signals or when interfacing to components or busses which are pulled up to 5V. In the first case, when interfacing to non-TTL inputs such as ACMOS or HCMOS where full 5V signal swings are needed, the LVXC4245 can act as an amplifier to translate 0 volt to 3 volt signals up to 0 volt to 5 volt levels as shown in *Figure 2*.

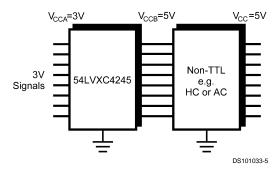


FIGURE 2. LVXC4245 amplifies 3V signals for interfacing to non-TTL inputs.

In the second case, when interfacing to busses which use resistive pull-ups to 5V, it is desirable to avoid connecting 3V devices directly to the bus to avoid excessive power con-

sumption. The LVXC4245 can be used to translate the 3 volt signals to 5 volt levels and eliminate the power consumed by the pull-up resistors.

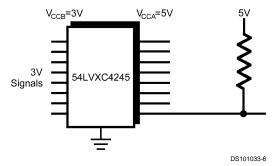
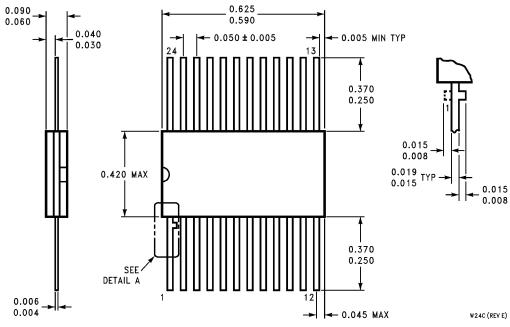
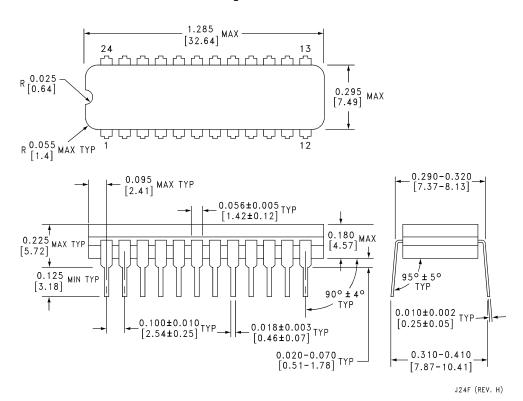


FIGURE 3. LVXC4245 for interfacing to 5V busses with pull-ups minimizes power consumption.

### Physical Dimensions inches (millimeters) unless otherwise noted



24-Lead Ceramic Flatpack Package Number W24C



24-Lead Ceramic Dual-in-line Package Number J24F

### **Notes**

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